

Probing out-of-plane heat transport in layered quantum materials using time-resolved Raman thermometry

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Understanding heat transport (in-plane and out-of-plane) in layered quantum materials is essential to enhance their performance in spintronics, optoelectronics and energy harvesting [1]. Though established optical techniques can efficiently observe in-plane heat transport [2] existing techniques for out-of-plane heat flow require several known input parameters and complex analysis procedures [3]. Hence, it is desirable to develop a new experimental approach to properly assess the out-of-plane transport of heat in layered quantum materials and their heterostructures.

In this work, we introduce a novel time-resolved Raman thermometry (TRRT) technique that enables the study of out-of-plane thermal transport in 2D layered materials. We use an ultrafast pump pulse to generate an out-of-plane flow of heat in a van der Waals stack. We then send a probe pulse on the sample to acquire Raman spectra as a function of the pump-probe delay. Since Raman scattering is temperature sensitive and each material has unique Raman peaks [4], this allows us to follow the temperature dynamics in the different layers of a van der Waals stacks.

Thanks to this promising technique, we envision new ways of measuring interfacial thermal properties by directly observing heat transport in each layer of a composite material stack.

Reference

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